

# BSS138W-G

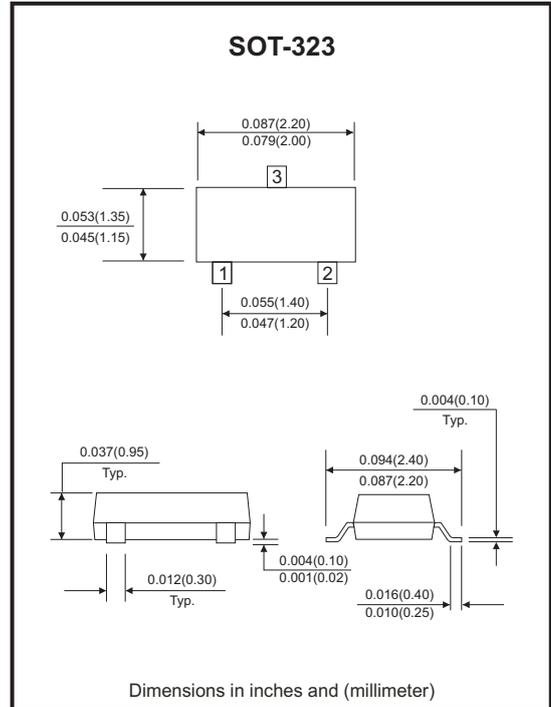
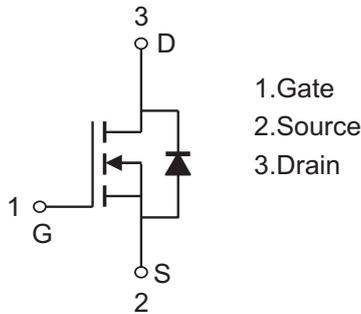
N-Channel  
RoHS Device



## Features

- Low on-resistance.
- Low gate threshold voltage.
- Low input capacitance.
- Fast switching speed.
- Low input/output leakage.

## Circuit diagram



## Maximum Ratings and Electrical Characteristics

(at Ta=25 °C unless otherwise noted)

Parameter	Symbol	Value	Units
Drain-Source voltage	V <sub>DSS</sub>	50	V
Drain-Gate voltage	R <sub>GS</sub> ≤ 20KΩ V <sub>DGR</sub>	50	V
Gate-Source voltage	V <sub>GSS</sub>	±20	A
Drain current	- continuous I <sub>D</sub>	200	mA
Power dissipation	P <sub>D</sub>	200	mW
Thermal resistance from junction to ambient	R <sub>θJA</sub>	417	°C/W
Junction temperature	T <sub>J</sub>	150	°C
Storage temperature	T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (at TA=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	50	75	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	1.2	1.5	V
Gate leakage current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$	-	-	$\pm 100$	nA
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=50V, V_{GS}=0V$	-	-	0.5	$\mu A$
Forward transfer admittance	$g_{FS}$	$V_{DS}=25V, I_D=0.2A, f=1.0MHz$	100	-	-	mS
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=0.22A$	-	1.4	3.5	$\Omega$
Input capacitance	$C_{iss}$	$V_{DS}=10V, V_{GS}=0V, f=1.0MHz$	-	-	50	pF
Output capacitance	$C_{oss}$		-	-	25	
Reverse transfer capacitance	$C_{rss}$		-	-	8	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=30V, I_D=0.2A$ $R_{GEN}=50\Omega$	-	-	20	nS
Turn-off delay time	$t_{d(off)}$		-	-	20	

RATING AND CHARACTERISTIC CURVES (BSS138W-G)

Fig.2 - Drain Source Current vs. Drain Source Voltage

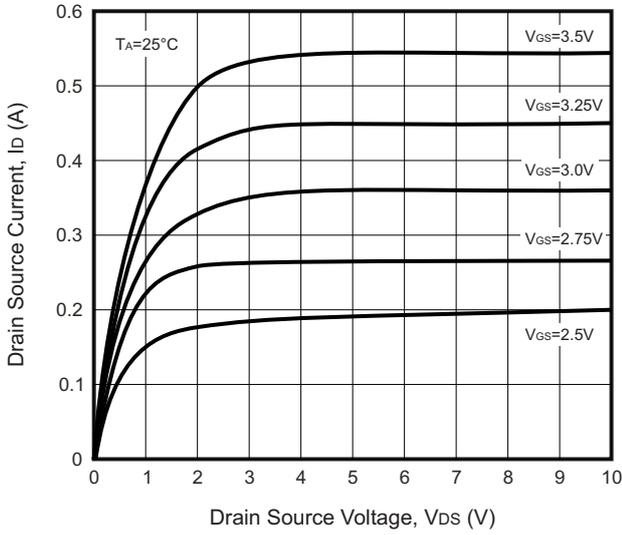


Fig.2 - Transfer Characteristics

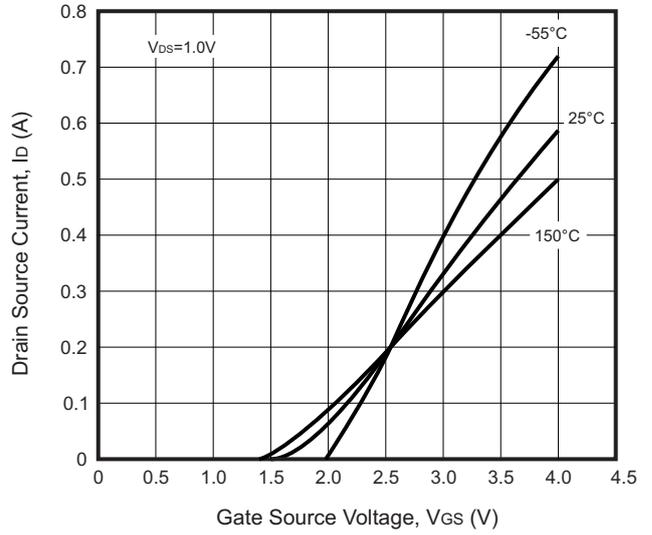


Fig.3 - Body Diode Current vs. Body Diode Voltage

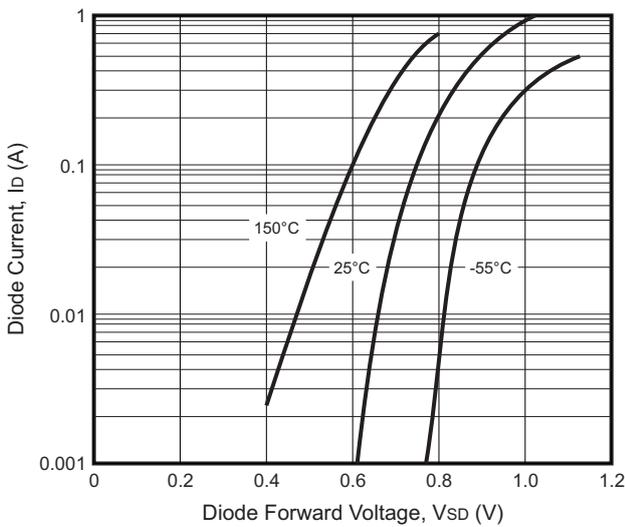
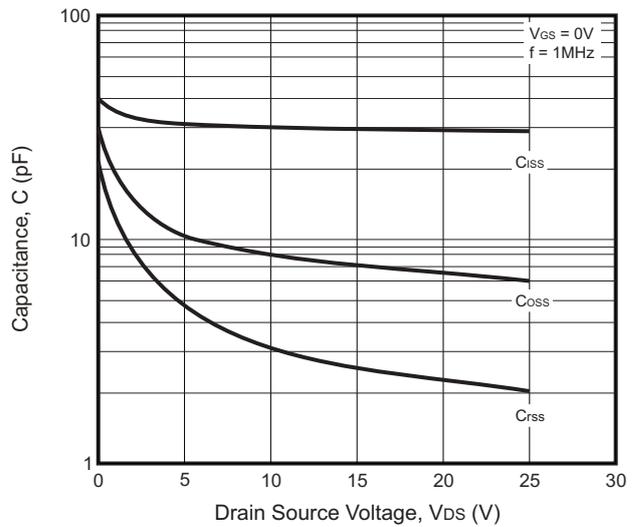
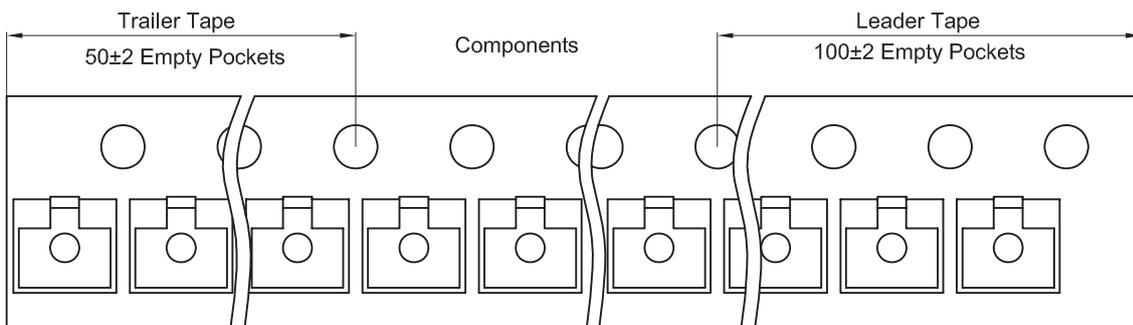
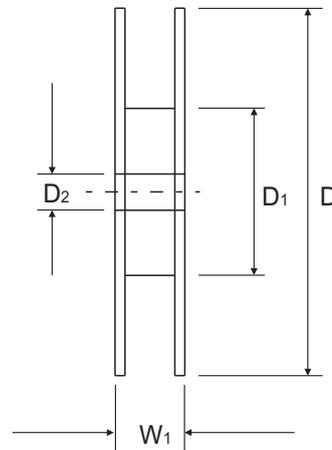
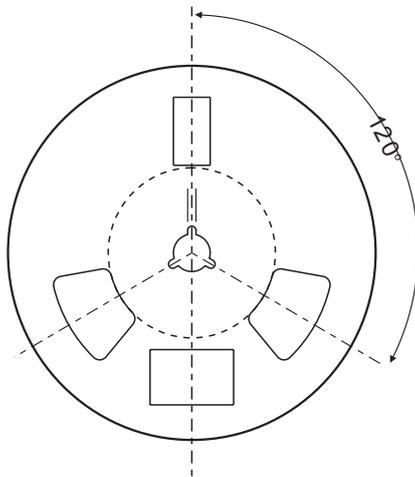
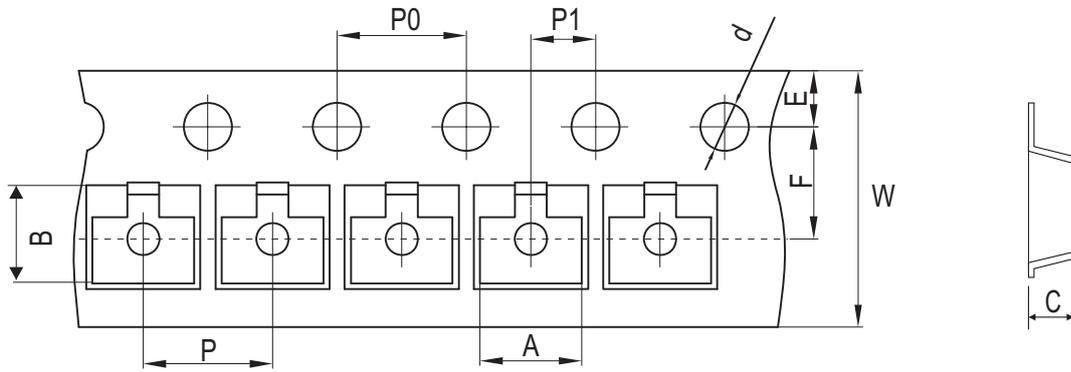


Fig.4 - Capacitance vs. Drain Source Voltage



Company reserves the right to improve product design, functions and reliability without notice.

Reel Taping Specification



SOT-323	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	2.40 ± 0.10	2.40 ± 0.10	1.20 ± 0.10	1.50 ± 0.10	178.00 ± 1.00	54.40 ± 0.50	13.00 ± 0.50
	(inch)	0.094 ± 0.004	0.094 ± 0.004	0.047 ± 0.004	0.059 ± 0.004	7.087 ± 0.039	2.142 ± 0.020	0.512 ± 0.020

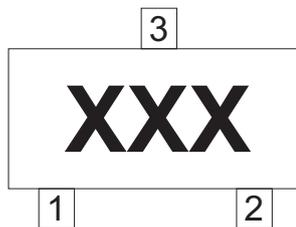
SOT-323	SYMBOL	E	F	P	P0	P1	W	W1
	(mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	8.00 + 0.30 / - 0.10	9.50 ± 1.00
	(inch)	0.069 ± 0.004	0.138 ± 0.002	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.315 + 0.012 / - 0.004	0.374 ± 0.039

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REV: A

## Marking Code

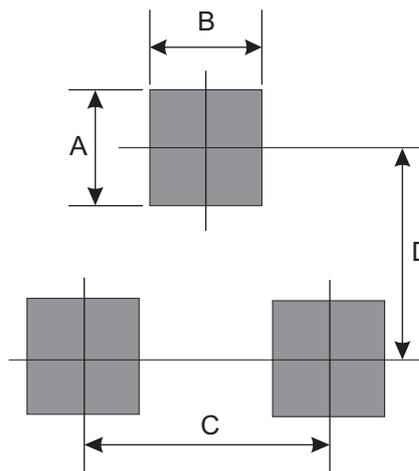
Part Number	Marking Code
BSS138W-G	K38



xxx = Product type marking code

## Suggested PAD Layout

SIZE	SOT-323	
	(mm)	(inch)
A	0.90	0.035
B	0.70	0.028
C	1.30	0.051
D	1.90	0.075



Note:

1. The pad layout is for reference purposes only.

## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
SOT-323	3,000	7

# Mouser Electronics

Authorized Distributor

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